NUMBER	GS-12-1634	PRODUCT SPECIFICATION	≣FCi B a	asics
TITLE			PAGE	REVISION
	MicroSpaceXS™ connector		1 of 14	Н
			VALLIERE Jérôme	12/12/2024
			CLASSIFICATION UNRESTRIC	TED

1.0 Objective

This specification defines the performance, test, quality and reliability requirements of the MicroSpaceXS™ product.

2.0 Scope

This specification is applicable to the termination characteristics of the MicroSpaceXS[™] family of products which provides a unique design enables LV214 (Severity 2) & USCAR-2 (T2V2) compliant for Tin plating and enables LV214 (Severity 3) & USCAR-2 (T4V2) for Gold plating.

MicroSpaceXS[™] will be available in:

- 1.27mm (Staggered) pitch.
- Wire-To-Board and Wire-To-Wire configuration. Unsealed and Sealed
- Top and Side latch solution.
- Sealed Panel Mount configuration with LV214 & USCAR-2 (T2V2) compliant for Tin Plating

3.0 Ratings

- 3.1 Operating Voltage Rating = 12V-48V (For customer specification and more details, please contact us)
- 3.2 Operating Current Rating =

Standard terminal:

- Unsealed version : 4A max, T° rise : 30°C max
- Sealed version : 3A max, T° rise : 30°C max

Specific terminal (high current):

- Unsealed version : qualification value on going (A max), T° rise : 30°C max
- Sealed version : 5.9A max, T° rise : 30°C max
- 3.3 Operating Temperature Range =
 - Tin plating: -40°C to +105°C
 - Gold plating: -40°C to +150°C

4.0 Applicable Documents

- 4.1 AFCI Specifications
 - 4.1.1 Engineering drawings
 - 4.1.2 Process drawings
 - 4.1.3 Application specification(s)
 - GS-20-0657: MicroSpaceXS™ CTW application specification
 - 4.1.4 Material specification(s)

© 2016 AFCI

GS-12-1634 PRODUCT SPECIFICATION

FILE

MicroSpaceXS™ connector

PAGE
2 of 14
H

AUTHORIZED BY
VALLIERE Jérôme
12/12/2024

CLASSIFICATION
UNRESTRICTED

4.2 Industry or Trade Association standards

4.2.1 VW 75174 - 2018-06: Motor Vehicle Connectors

4.2.2 SAE/USCAR-2 Revision 7: Performance Specification for Automotive

Electrical Connector Systems

4.2.3 VW 60330: Crimp Connections – Solderless Electrical Connections

4.3 National or International Standards

- 4.3.1 Flammability: UL94V-0 or similar applicable specification
- 4.3.2 EIA 364: Electrical Connector/Socket Test Procedures Including Environmental Classifications.
- 4.3.3 IEC 60512 : Connectors for Electronic Equipment Tests and Measurement
- 4.3.4 IPC-A-610D: Acceptability of Electronic Assemblies
- 4.3.5 IEC-60664-1: Insulation coordination for equipment within low-voltage supply systems
- 4.3.6 IPC-2221 : Generic Standard on Printed Board Design
- 4.4 AFCI Laboratory Reports Supporting Data
- 4.5 Safety Agency Approvals

5.0 Requirements

© 2016 AFCI

5.1 Qualification

Connectors furnished under this specification shall be capable of meeting the qualification test requirements specified herein.

5.2 Material

The material for each component shall be as specified herein or equivalent.

- 5.2.1 Header housing: LCP 30% Glass fiber reinforced Halogen free, UL94V-0, color black or other
- 5.2.2 Receptacle housing / Terminal Position Assurance / Connector Position Assurance :

PPA 30% Glass fiber reinforced Halogen free, UL94V-0, color black or other

5.2.3 Seals:

Liquid silicone rubber grade 50±5 shore A, color black

Solid silicone rubber grade 20±5 shore A color blue or other

Solid silicone rubber grade 40±5 shore A color yellow

5.2.4 Metallic parts:

Header contacts: Phosphor Bronze alloy

CTW terminals (Receptacle and Header): Copper-Nickel Alloy / C70250

CTW terminal high current (Header): Copper-Iron Alloy / C19210

Hold-down: Phosphor Bronze alloy Panel Mount inserts: Carbon steel

Form E-3701 – Revision D GS-01-029

GS-12-1634 PRODUCT SPECIFICATION

FILE

MicroSpaceXS™ connector

PAGE

3 of 14

H

AUTHORIZED BY
VALLIERE Jérôme

CLASSIFICATION

UNRESTRICTED

5.2.5 Wire cable:

Conductor: bare, stranded copper wires, material Cu-ETP1

Insulator : TPE-E

Gauge: AWG22 to AWG28. AWG22 used for qualification tests

5.3 Finish

The finish for applicable components shall be as specified herein or equivalent.

- Full Tin Plated

- Selective Gold plating

5.4 Design and Construction

Connectors shall be of the design, construction, and physical dimensions specified on the applicable product drawing. There shall be no cracks, burrs, or other physical defects that may impair performance.

NUMBER	GS-12-1634	PRODUCT SPECIFICATION	≣FCi B a	asics
TITLE			PAGE 4 of 14	REVISION H
	MicroSpaceXS™ connector		AUTHORIZED BY VALLIERE Jérôme	DATE 12/12/2024
			CLASSIFICATION UNRESTRIC	:TFD

6.0 Electrical, Mechanical and Environmental Tests according to LV214 (VW 75174 - 2018-06)

ITEM	TESTS	REQUIRMENTS	TEST SUBJECT
6.1	TG 0 Inspection of as-received condition	 Volume resistance < 30mΩ (for 0.35mm² conductor cross section) R_{ins} > 100 MΩ at V = 500 V, t= 60 s 	All variants
6.2	TG 1 Dimensions	Dimension reports corresponding to customer drawing	All variants
6.3	TG 2 Material and surface analysis, contacts	Material specifications of contacts parts corresponding to customer drawing	All variants
6.4	TG 3 Material and surface analysis, housings and single-wire seals	Material specifications of contacts parts corresponding to customer drawing	All variants
6.5	TG 4 Contact engagement length	Contacts engagement length > 1mmClearance > 0mm (worst case)	All variants
6.6	TG 5 Mechanical and thermal relaxation behavior	 Contact opening variation (documented) Normal contact force variation (documented) 	All variants
6.7	TG 6 Interaction between contact and housing	 Drop test (stability of housing and locks) Primary & Secondary lock/latch play Actuation forces for the Secondary locking device (TPA) Opening: 10 to 50N (Fo) Closing for slide (correct assembled terminals) < 50N (Fc) Closing (improperly assembled terminals) > Fc + 25N or > 3xFc 	All variants

GS-12-1634 PRODUCT SPECIFICATION

FITLE

MicroSpaceXS™ connector

PAGE

S of 14

AUTHORIZED BY
VALLIERE Jérôme

CLASSIFICATION

CLASSIFICATION

TYPE

PRODUCT SPECIFICATION

PAGE

S of 14

H

AUTHORIZED BY
VALLIERE Jérôme

CLASSIFICATION

6.8	TG 7 Handling and functional reliability of the housing	 Keying efficiency > 80N and > 3xFe Test condition: "free" representative orientation (1) Polarizing efficiency > 80N and > 3xFe Positive locking retention > 60N (unequipped housings) Insertion/actuation force < 75N (Fe) CPA actuation force: 5 – 30 N CPA efficiency: > 50N (1) 	All variants
6.9	TG 8 Insertion and retention forces of the contact parts in the housing	 Terminal insertion force < 3N (unsealed), <10N (sealed) Terminal retention force (clean body) 1st locking only > 20N (1) 2nd locking only > 35N 	All variants
6.10	TG 9 Pin insertion inclination/misuse safe	- Examination is performed using CAD	All variants
6.11	TG 10 Contacts: conductor pull- out strength	- Conductor pull-out strength: AWG 22: > 50N (from VW 75174) AWG 24: > 35N AWG 26: > 25N AWG 28: > 18N	All variants
6.12	TG 11 Contacts: Insertion and removal forces, mating cycle frequency	 Mating cycles: 20 (Tin plated) 100 (Gold plated) Contact opening variation (documented) Insertion/Extraction force variation <25% 	All variants
6.13	TG 12 Current heating, derating	- Derating curve (documented)	All variants
6.14	TG 13 Housing influence on the derating	- Derating curve (documented)	All variants
6.15	TG 14 Thermal time constant (current excess temperature at n times rated current)	- Graph "Current over time" (documented)	All variants

© 2016 AFCI

UNRESTRICTED

GS-12-1634

PRODUCT SPECIFICATION

FILE

MicroSpaceXS™ connector

PAGE
6 of 14
H

AUTHORIZED BY
VALLIERE Jérôme
12/12/2024

CLASSIFICATION
UNRESTRICTED

6.16	TG 15 Electrical stress test TG 16 Friction corrosion	 Contact opening variation (documented) Volume resistance < 30mΩ (for 0.35mm² conductor cross section) Derating curve variation <20% Graph "Volume resistance over cycles" (documented) 	All variants All variants
		- Number of cycles for 300mΩ volume resistance	
6.18	TG 17 Dynamic load	 Severity 2 for Tin plating – Unsealed Severity 2 for Tin plating – Sealed WTW Panel mount Severity 3 for Tin plating - Sealed Severity 3 for Gold plating Volume resistance < 30mΩ (for 0.35mm² conductor cross section) No functions deviations 	All variants
6.19	TG 18A Coastal climate load	- Volume resistance < 30mΩ (for 0.35mm² conductor cross section)	Unsealed versions
6.20	TG 19 Environmental simulation	 Volume resistance < 30mΩ (for 0.35mm² conductor cross section) For Tin version Group1 only ⁽¹⁾ 	All variants
6.21	TG 20 Climate load of the housing	 Insulation resistance > 100 MΩ No functions deviations 	All variants
6.22	TG 21 Long-term temperature aging	 Volume resistance < 30mΩ (for 0.35mm² conductor cross section) Conductor pull-out strength (same as TG10) No functions deviations 	All variants
6.23	TG 22A Resistance to chemicals	- Insulation resistance > 100 $M\Omega$ - No functions deviations	All variants

NUMBER	GS-12-1634	PRODUCT SPECIFICATION	≣FCi B	asics
TITLE			PAGE 7 of 14	REVISION H
	MicroSpaceXS™ connector		AUTHORIZED BY VALLIERE Jérôme	DATE 12/12/2024
			CLASSIFICATION LINRESTRIC	TFD

6.24	TG 22B Chemical resistance, extended testing	 Insulation resistance > 100 MΩ No functions deviations 	Sealed versions
6.25	TG 23 Water tightness	 IP68 and IP69K Insulation resistance > 100 MΩ No medium penetration No functions deviations 	Sealed versions only compatible with AWG22 / AWG24 wire
6.26	TG 24 Impenetrability to paint	No dip paint penetrationNo functions deviations	All variants
6.27	TG 28 Latching noise	- L _{Apeak} > 50 dB(A) ⁽¹⁾	All variants
6.28	TG 31 Holding forces for contact pins and contact blades in plastic contact housings	- Holding force > 5N	Wire-To-Board configuration
6.29	Slow Motion Bending Test	- Max permissible resistance change ΔR $\leq 1 m\Omega$ for ΔR 1 dispersion of all test specimens (new state) $\leq 3 m\Omega$ for ΔR 2, ΔR 3 for each specimen (from the start of the test to the end)	All variants

^{(1) :} Dedicated value. MicroSpaceXS™ connector

For product qualification latest status please contact us

NUMBER	GS-12-1634	PRODUCT SPECIFICATION	≣FCi B	asics
TITLE			PAGE 8 of 14	REVISION H
	MicroSpaceXS™ connector		AUTHORIZED BY VALLIERE Jérôme	DATE 12/12/2024
		CLASSIFICATION UNRESTRIC	CTED	

7.0 Electrical, Mechanical and Environmental Tests according to USCAR-2 Revision 7

ITEM	TESTS	REQUIRMENTS	TEST SUBJECT
7.1	A Terminal-to-Terminal Engage/Disengage Force	Mating cycles : 10No base material exposed	All variants
7.2	B Terminal Bend Resistance	- Applied bending force : 3N	All variants
7.3	C Maximum Current/Current Cycling	- Maximum current capability @ ∆T≤55°C (documented)	All variants
7.4	D TermConn. Insertion/Retention	 Insertion force: 30N max Primary Lock Retention: 20N min Prim+Second Lock Retention: 40N min⁽²⁾ 	All variants
7.5	E Misc. Component Engage/Disengage	TPA - Pre-set to lock: TPA engagement force: 60N max (with terminals fully loaded) TPA engagement force: 15N min (without terminals) TPA - Lock to pre-set: TPA removal force: 60N max (with terminals fully loaded) TPA removal force: 18N min (after 2 cycles) TPA - Complete removal from pre-set: TPA removal force: 15N min CPA - Pre-set to lock: CPA blocking force: > 50Nmin (1) (unmated) CPA - Lock to pre-set: CPA removal force: >10N and <30N CPA - Complete removal from pre-set: CPA removal force: 30N min	All variants
7.6	F Connector-to-connector audible click	- Audible click (documented)	All variants

GS-12-1634 PRODUCT SPECIFICATION

FILE

MicroSpaceXS™ connector

PAGE

9 of 14

H

AUTHORIZED BY
VALLIERE Jérôme

12/12/2024

VALLIERE Jérôme 12/12/2024
CLASSIFICATION
UNRESTRICTED

7.7	G Conn. Conn Mating/Un- mating	 Mating force: 75N max Retention force (lock engaged): 110N min Unmating force (lock disengaged): 75N max Lock disengagement force: >2N (1) 	All variants
7.8	H Polarization Effectiveness	- Keying and Polarization efficiency :> 3xFe (Mating force) with force being >60N and <150N Test condition : "free" representative orientation (1)	All variants
7.9	l Drop	 No deterioration, cracks, deformities, No components displacement from their intended shipping position 	All variants
7.10	J Cavity Damage	 TPA engagement force: 60N min (with terminals in unseated position) No deterioration, cracks, deformities, 	All variants
7.11	AE Terminal/Cavity Polarization	- Sealed version: Receptacle terminal: Normal insertion force in incorrect orientation (90°, 180° and 270°): 15N min Header terminal: Normal insertion force in incorrect orientation (180°): Terminals can be fully inserted but freely pulled out from cavities (1) Unsealed version: Normal insertion force in incorrect orientation (90° and 270°): 15N min Normal insertion force in incorrect orientation (180°): Terminals can be fully inserted but freely pulled out from cavities (1) - No deterioration, cracks, deformities,	All variants
7.12	K Header Pin Retention	Retention force with a pin displacement of 0.2mm max : 15N min	All variants

NUMBER **≢FCi** Basics GS-12-1634 **PRODUCT SPECIFICATION** TITLE PAGE 10 of 14 AUTHORIZED BY MicroSpaceXS™ connector DATE

> CLASSIFICATION UNRESTRICTED

VALLIERE Jérôme

12/12/2024

		<u></u>	
7.13	L Mounting Feature Mechanical Strength	- Force required to break or separate from mounting feature : - 50N min (force F1 to F5) - 110N min (force F6) Mounting Mating Avia Mounting F1 F2 NOTE: "F" Arrows indicate direction of applied force, not location of probe	Wire-To-Wire configuration
7.15	Y Conn. Seal Retention – Unmated Connector	No components (seals) displacement from their intended shipping position	Sealed versions
7.16	Z Conn. Seal Retention – Mated Connector	No components (seals) displacement from their intended shipping position	Sealed versions
7.17	M Vibration	 Class: T2V2 for Tin plating Class: T4V2 for Gold plating Total connection resistance: 25mΩ max Voltage drop: 50mV max 	All variants
7.18	N Thermal Shock	 Class: T2 for Tin plating Class: T4 for Gold plating Total connection resistance: 25mΩ max Voltage drop: 50mV max 	All variants
7.19	O Temp / Humidity Cycling	 Class: T2 for Tin plating Class: T4 for Gold plating Total connection resistance: 25mΩ max Voltage drop: 50mV max Insulation resistance > 100 MΩ at 500 VDC 	All variants

NUMBER	GS-12-1634	PRODUCT SPECIFICATION	≣FCi B	asics
TITLE			PAGE 11 of 14	REVISION H
MicroSpaceXS™ connector		AUTHORIZED BY VALLIERE Jérôme	DATE 12/12/2024	
		CLASSIFICATION LINE STRIC	CTED	

	T		1	
7.20	P High Temperature Exposure	 Class: T2 for Tin plating Class: T4 for Gold plating Total connection resistance: 25mΩ max Voltage drop: 50mV max 	All variants	
7.21	Q Fluid Resistance	- No functions deviations	Sealed versions	
7.22	RSAA Temp/Humidity Submersion PV Leak Submersion High Press. Spray	 Class: T2 for Tin plating Class: T4 for Gold plating IP68 and IP69K Insulation resistance > 100 MΩ at 500 VDC 	Sealed versions only compatible with AWG22 / AWG24 wire	
7.23	TUAB High Temp Exposure PV Leak Submersion High Press. Spray	 Class: T2 for Tin plating Class: T4 for Gold plating IP68 and IP69K Insulation resistance > 100 MΩ at 500 VDC 	Sealed versions only compatible with AWG22 / AWG24 wire	
7.24	USCAR 21	- Crimp geometry (documented) - Conductor pull-out strength: AWG 22: > 50N AWG 24: > 35N (1) AWG 26: > 25N (1) AWG 28: > 18N (1) - Dry circuit resistance variation <0.47mΩ	All variants	

(1) : Dedicated value or dedicated test condition. MicroSpaceXS $^{\mbox{\tiny TM}}$ connector

(2) : 30N mini for Terminal male high current

For product qualification latest status please contact us

Form E-3701 – Revision D

GS-12-1634 PRODUCT SPECIFICATION

FILE

MicroSpaceXS™ connector

PAGE
12 of 14
H

AUTHORIZED BY
VALLIERE Jérôme
12/12/2024

CLASSIFICATION
UNRESTRICTED

8.0 Additional Electrical, Mechanical and Environmental Tests

ITEM	TESTS	REQUIRMENTS	TEST SUBJECT /STANDARD	
8.1	Breaking Voltage Test	 Voltage: 500VAC no evidence of arc-over, insulation breakdown, or excessive leakage current >1mA 	All variants EIA-364-20	
8.2	Tin Whisker Formation	 Temp cyling: -55°C/+85°C, 1500 cycles High temp / Humidity aging: 55°C/85%RH, 4000 hr There shall be no evidence of whiskers higher than 50µm 	WtB configuration Tin Post-plated JEDEC JESD-201A	
8.3	Solderability	Condition E (Dry bake preconditioning)Solder coverage >95%	WtB configuration JEDEC J-STD-002E	
8.4	Resistance to solder heat	- Reflow 260°C, 3 cycles	WtB configuration AFCI GS-22-011	
8.5	MSL test	 Level 1 under 260°C Max There shall be no evidence of tin reflowing and discoloration on power pins 	WtB configuration JEDEC J-STD-020E	
8.6	Holding sheet push out force (from housing)	- Force before breakage or separation : 50N min	WtB configuration	
8.7	Pull on wire (connector soldered on PCB)	Force before breakage or separation in all direction : 50N min	WtB configuration	
8.8	Connector shear force (soldered on PCB)	Force before breakage or separation in parallel direction to PCB : 300N min	WtB configuration	

NUMBER TYPE **≢FCi Basics** GS-12-1634 PRODUCT SPECIFICATION REVISION TITLE PAGE 13 of 14 AUTHORIZED BY DATE MicroSpaceXS™ connector VALLIERE Jérôme 12/12/2024 CLASSIFICATION UNRESTRICTED

9.0 QUALITY ASSURANCE PROVISIONS

9.1 Equipment Calibration

All test equipment and inspection facilities used in the performance of any test shall be maintained in a calibration system in accordance with ANSI Z-540 and ISO 9000.

9.2 Inspection Conditions

Unless otherwise specified herein, all inspections shall be performed under the following ambient conditions:

a. Temperature: 25 +/- 5 deg Cb. Relative Humidity: 30% to 60%

c. Barometric Pressure: Local ambient

9.3 Sample Quantity And Description

Refer to called standards.

9.4 Acceptance

- 7.4.1 Electrical and mechanical requirements placed on test samples as indicated in paragraphs 6.0 shall be established from test data using appropriate statistical techniques or shall otherwise be customer specified, and all samples tested in accordance with this product specification shall meet the stated requirements.
- 7.4.2 Failures attributed to equipment, test setup, or operator error shall not disqualify the product. If product failure occurs, corrective action shall be taken and samples resubmitted for qualification.

9.5 Qualification Testing

Qualification testing shall be performed on sample units produced with equipment and procedures normally used in production. The test sequences shall be as shown in the qualification test table. Data shall be provided with the samples noting production history: production lot codes for components and assemblies, components and assemblies produced to print revision ___, verification of plating composition and thickness, etc.

9.6 Re-Qualification Testing

© 2016 AFCI

If any of the following conditions occur, the responsible product engineer shall initiate requalification testing consisting of all applicable parts of the qualification test matrix.

- a. A significant design change is made to the existing product which impacts the product form, fit or function. Examples of significant changes shall include, but not be limited to, changes in the plating material composition or thickness, contact force, contact surface geometry, insulator design, contact base material, or contact lubrication requirements.
- b. A significant change is made to the manufacturing process which impacts the product form, fit or function.
- c. A significant event occurs during production or end use requiring corrective action to be taken relative to the product design or manufacturing process.

Form F-3701 – Revision D

GS-12-1634 PRODUCT SPECIFICATION

FILE

PAGE

14 of 14

H

AUTHORIZED BY

VALLIERE Jérôme

CLASSIFICATION

UNRESTRICTED

TYPE

PAGE

14 of 14

H

AUTHORIZED BY

VALLIERE Jérôme

CLASSIFICATION

UNRESTRICTED

REVISION RECORD

Rev	<u>Page</u>	<u>Description</u>	EC#	<u>Date</u>
Α	ALL	Creation		
В	4, 6, 8	Update of requirement for TG7 and TG28 (LV214), Group E, G, H and AE (USCAR)		02/07/2021
С	1, 6, 10	1.8mm pitch version removed. AWG22 and AWG24 wire is specified for sealing tests Mention "For product qualification latest status please contact us" added		25/08/21
D	1, 2, 4, 5, 6, 8, 9, 10, 11	Section 3.2 and 3.3 - Updated Section 5.2.3 - Updated Section 5.3 - Updated Item 6.12 - Adding Gold version Item 6.18 - TG17 severity changes Item 6.20 - TG19 modification Item 6.25 - IP68 & IP69K Item 7.11 - Header terminal polarization change Item 7.17 to 7.20 - Adding Gold version Item 7.22 - RSAA merged Item 7.23 - TUAB merged Item 7.24 - Adding USCAR 21 Item 8.6 - Change from 20N to 50N Item 8.7 - Change from 30N to 50N	F-49631	31/10/2023
E	1,9,10	Adding Gold mention Item 7.17 Vibration range change for Gold plating Item 7.18 to 7.20 Vibration range suppressed Item 7.22 & 7.23 Vibration range suppressed		21/06/2024
F	1, 3	Add variant voltage application Add WTB Sealed Panel Mount Configuration (USCAR2)	F-53654	08/11/2024
G	1, 2, 6, 8, 11	Add WTB Sealed Panel Mount Configuration (LV214 Sev3) Add Material seal & inserts of WTB Sealed Panel Mount Section 3.2 : adding current value max for specific terminal Section 5.2.4 : adding material for terminal high current Item 7.4 – Gr D : adding notes (2) Section 2 & Item 6.18 : Add WTW Sealed Panel Mount Configuration (LV214 Sev2 & USCAR2)	F-54013	28/02/2025

© 2016 AFCI